

### SURFACE MOUNT SWITCHING DIODE

### **Features**

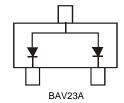
- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- High Conductance
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 3 and 4)
- · Qualified to AEC-Q101 Standards for High Reliability

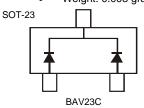
### **Mechanical Data**

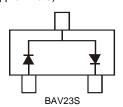
- Case: SOT-23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagrams Below
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.008 grams (approximate)



TOP VIEW







## **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Repetitive Peak Reverse Voltage		$V_{RRM}$	250	V
Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RWM</sub> V <sub>R</sub>	200	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	141	V
Forward Continuous Current (Note 2)		I <sub>FM</sub>	400	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 100μs @ t = 10ms	I <sub>FSM</sub>	9.0 3.0 1.7	А
Repetitive Peak Forward Surge Current (Note 2)		I <sub>FRM</sub>	625	mA

## Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 2)	P <sub>D</sub>	350	mW
Thermal Resistance Junction to Ambient Air (Note 2)	$R_{ hetaJA}$	357	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

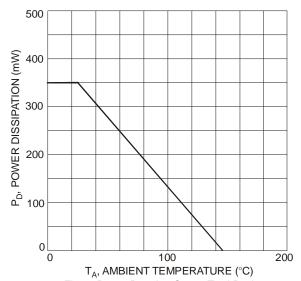
## **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	$V_{(BR)R}$	250	_	V	$I_R = 100 \mu A$
Forward Voltage (Note 1)	V <sub>F</sub>	_	1.0 1.25	V	$I_F = 100 \text{mA}$ $I_F = 200 \text{mA}$
Reverse Current @ Rated DC Blocking Voltage (Note 1)	I <sub>R</sub>	_	100	nA μA	$T_J = 25$ °C $T_J = 150$ °C
Total Capacitance	C <sub>T</sub>	_	5.0	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>	_	50	ns	$I_F = I_R = 30 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

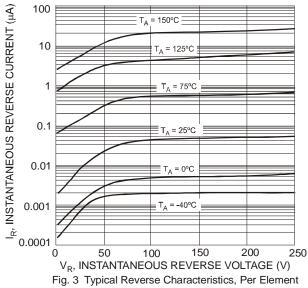
Notes:

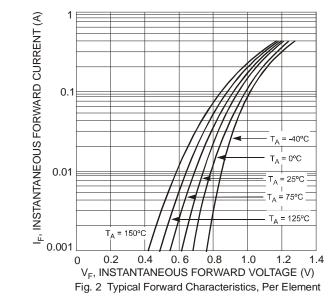
- 1. Short duration pulse test used to minimize self-heating effect.
- 2. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 3. No purposefully added lead. Halogen and Antimony Free.
- 4. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.











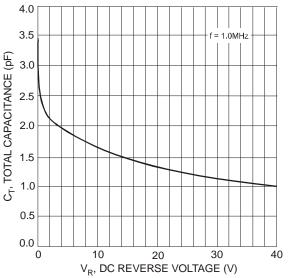


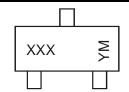
Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

# Ordering Information (Note 5)

Part Number	Case	Packaging
BAV23A-7-F	SOT-23	3000/Tape & Reel
BAV23C-7-F	SOT-23	3000/Tape & Reel
BAV23S-7-F	SOT-23	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## **Marking Information**



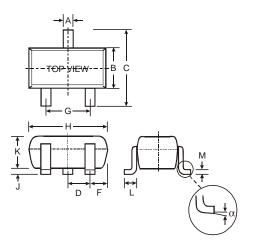
XXX = Product Type Marking Code
ex. KT7 = BAV23A
KT6 = BAV23C
KL31 = BAV23S
YM = Date Code Marking
Y = Year ex: N = 2002
M = Month ex: 9 = September

Date Code Kev

Date Code Rey												
Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	М	N	Р	R	S	Т	U	V	W	Х	Υ	Z
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

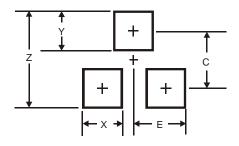


# **Package Outline Dimensions**



SOT-23					
Dim	Min	Max			
Α	0.37	0.51			
В	1.20	1.40			
С	2.30	2.50			
D	0.89	1.03			
F	0.45	0.60			
G	1.78	2.05			
Н	2.80	3.00			
J	0.013	0.10			
K	0.903	1.10			
L	0.45	0.61			
M	0.085	0.180			
α	0°	8°			
All Dir	All Dimensions in mm				

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Υ	0.9
С	2.0
E	1.35

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